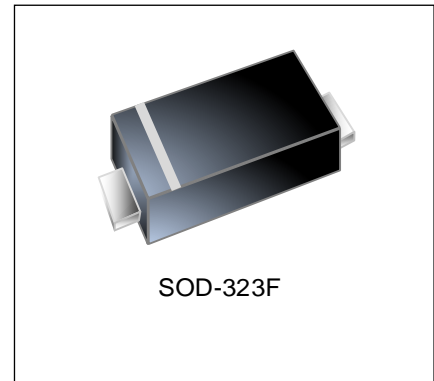


## Transient Voltage Suppressor

### Features

- 1260 Watts Peak Pulse Power per Line ( $t_p=8/20\mu s$ )
- Small Body Outline Dimensions
- Protects one I/O or power line
- Low Clamping Voltage
- Working Voltage: 4.5V
- Low Leakage Current



### IEC COMPATIBILITY (EN61000-4)

- IEC 61000-4-2 (ESD)  $\pm 30kV$  (air),  $\pm 30kV$  (contact)
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning)90A (8/20 $\mu s$ )

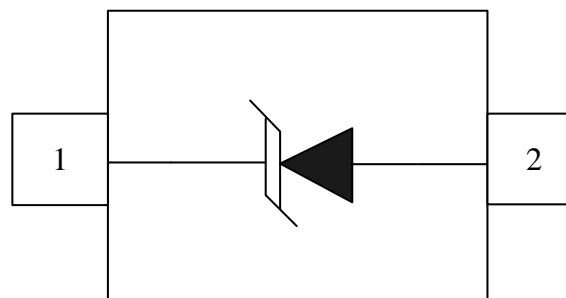
### Mechanical Characteristics

- SOD-323F package
- Marking : Marking Code
- Packaging : Tape and Reel
- RoHS Compliant & HF
- Device meets MSL3 requirement

### Applications

- Laptop Computers
- Cellular Phones
- Digital Cameras
- Personal Digital Assistants (PDAs)

### Schematic & PIN Configuration



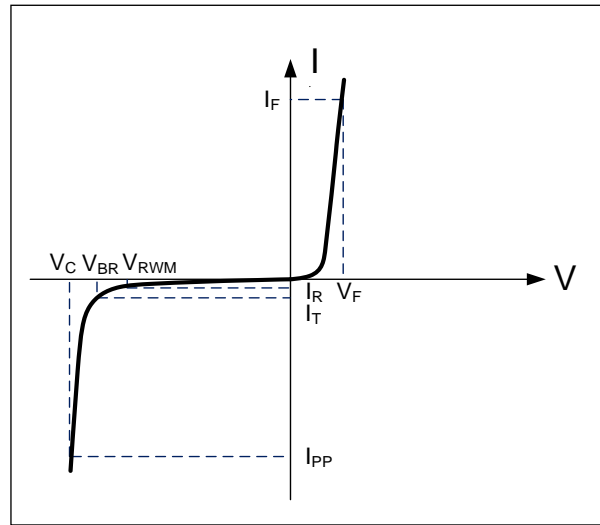
SOD-323F (Top View)

**Absolute Maximum Rating**

Rating	Symbol	Value	Units
Peak Pulse Power ( $t_p = 8/20\mu s$ )	P <sub>PP</sub>	1260	Watts
Peak Pulse Current ( $t_p = 8/20\mu s$ )	I <sub>PP</sub>	90	A
Operating Temperature	T <sub>J</sub>	-55 to + 125	°C
Storage Temperature	T <sub>STG</sub>	-55 to +150	°C

**Electrical Parameters**

Symbol	Parameter
I <sub>PP</sub>	Reverse Peak Pulse Current
V <sub>C</sub>	Clamping Voltage @ I <sub>PP</sub>
V <sub>RWM</sub>	Reverse Stand-Off Voltage
I <sub>R</sub>	Reverse Leakage Current @ V <sub>RWM</sub>
V <sub>BR</sub>	Breakdown Voltage @ I <sub>T</sub>
I <sub>T</sub>	Test Current
I <sub>F</sub>	Forward Current
V <sub>F</sub>	Forward Voltage @ I <sub>F</sub>



**Electrical Characteristics(T=25°C unless otherwise noted)**

WS4.5D3HP						
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V <sub>RWM</sub>				4.5	V
Reverse Breakdown Voltage	V <sub>BR</sub>	I <sub>T</sub> =1mA	5		7	V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> =4.5V			500	nA
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =10mA	0.5		1	V
Clamping Voltage	V <sub>C</sub>	I <sub>PP</sub> =90A, t <sub>p</sub> =8/20μs		12	14	V
Dynamic Resistance <sup>1,2</sup>	R <sub>DYN</sub>	TLP=0.2/100ns		0.05		Ω
ESD Clamping Voltage <sup>1</sup>	V <sub>C</sub>	I <sub>PP</sub> = 4A, t <sub>p</sub> = 0.2/100ns (TLP)		7		V
ESD Clamping Voltage <sup>1</sup>	V <sub>C</sub>	I <sub>PP</sub> = 16A, t <sub>p</sub> = 0.2/100ns (TLP)		7.6		V
Junction Capacitance	C <sub>j</sub>	V <sub>R</sub> = 0V, f = 1MHz		660	800	pF

**Note:** 1、 TLP Setting : t<sub>p</sub>=100ns, t<sub>r</sub>=0.2ns, I<sub>TLP</sub> and V<sub>TLP</sub> sample window:t<sub>1</sub>=70ns to t<sub>2</sub>=90ns.  
 2、 Dynamic resistance calculated from I<sub>PP</sub>=4A to I<sub>PP</sub>=16A using “Best Fit”

Typical Characteristics

Figure 1: Peak Pulse Power vs. Pulse Time

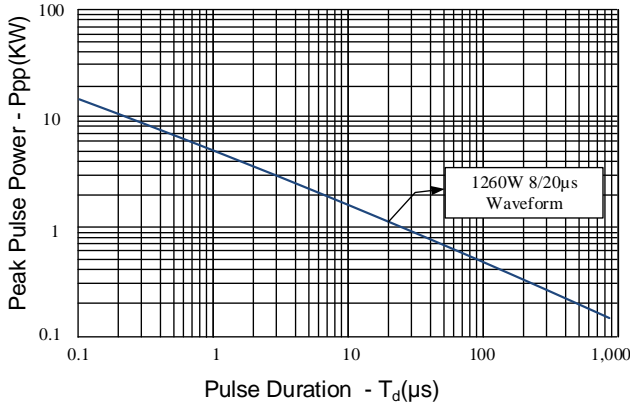


Figure 2: Power Derating Curve

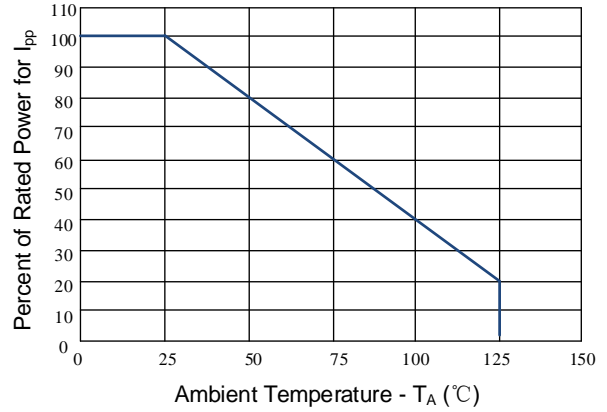


Figure 3: Clamping Voltage vs. Peak Pulse Current

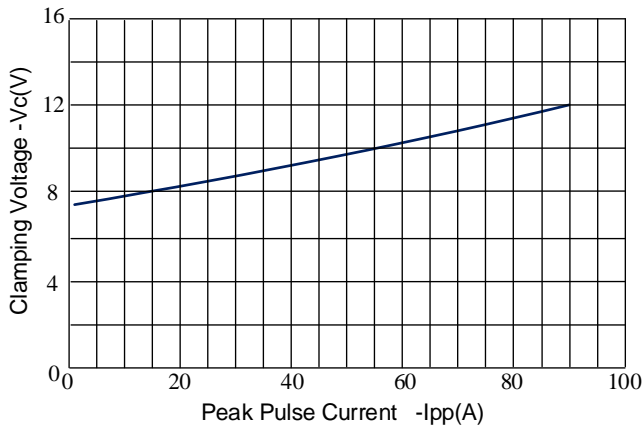


Figure 4: Normalized Junction Capacitance vs. Reverse Voltage

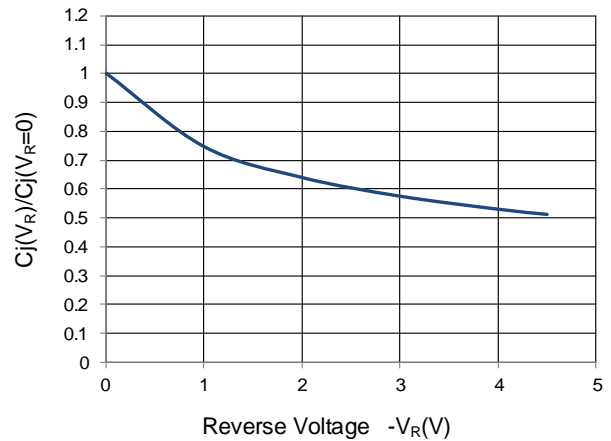


Figure 5: 8/20μs Pulse Waveform

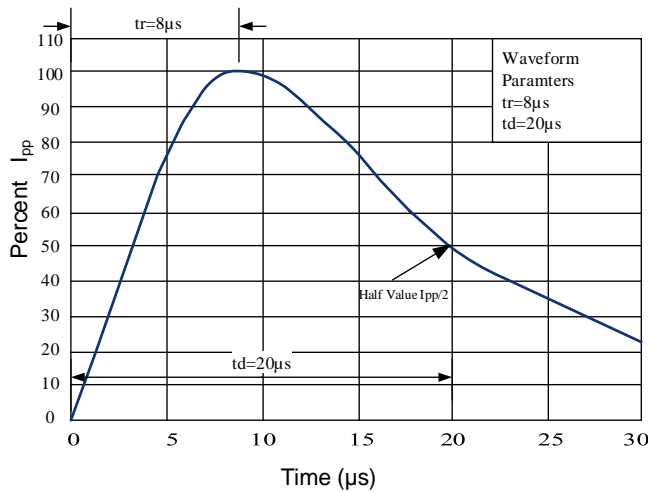
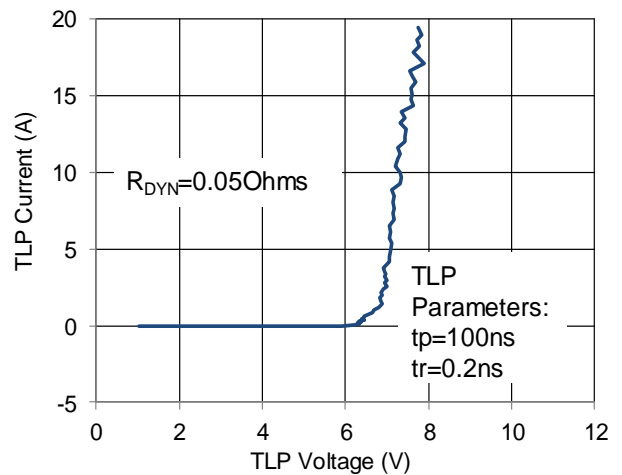
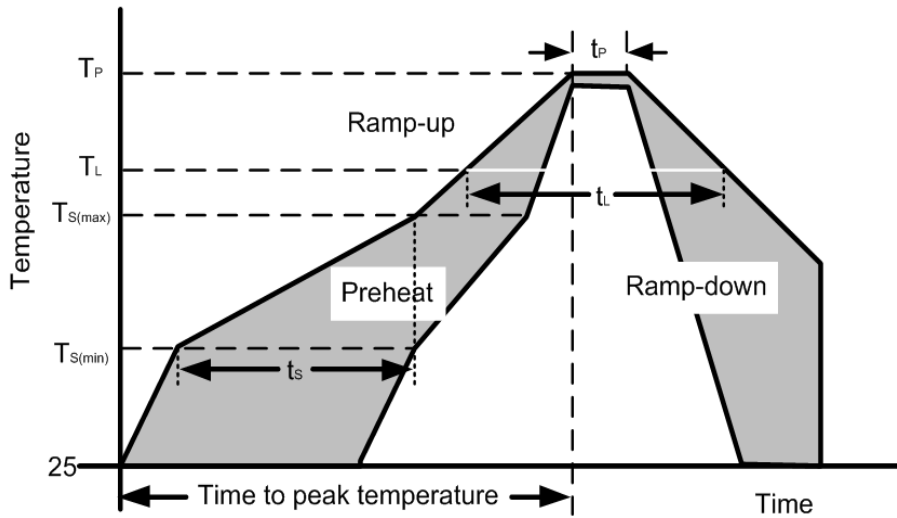


Figure 6: TLP Curve



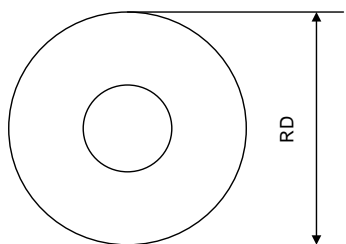
Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	Temperature Min ( $T_{S(min)}$ )	150°C
	Temperature Max ( $T_{S(max)}$ )	200°C
	Time (min to max) ( $t_s$ )	60 – 190 secs
Average ramp up rate (Liquidus Temp) ( $T_L$ ) to peak		5°C/second max
$T_{S(max)}$ to $T_L$ —Ramp-up Rate		5°C/second max
Reflow	Temperature ( $T_L$ ) (Liquidus)	217°C
	Temperature ( $t_L$ )	60 – 150 seconds
Peak Temperature ( $T_P$ )		260+0/-5 °C
Time within actual peak Temperature ( $t_p$ )		20 – 40 seconds
Ramp-down Rate		5°C/second max
Time 25°C to peak Temperature ( $T_P$ )		8 minutes Max.
Do not exceed		280°C

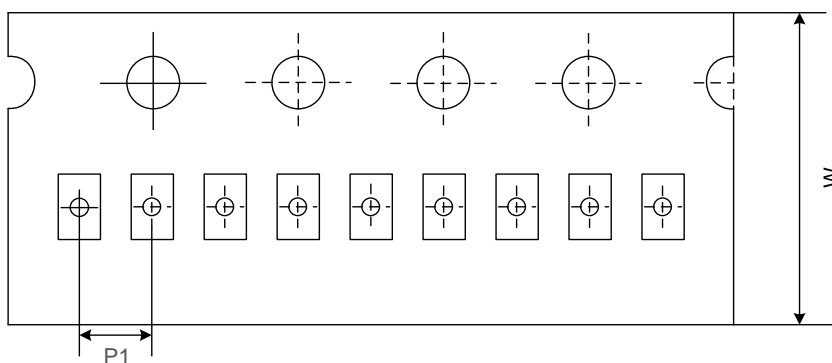


**Tape And Reel Information**

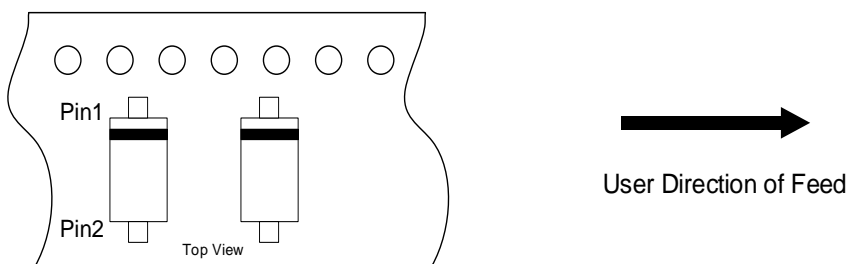
**Reel Dimensions**



**Tape Dimensions**

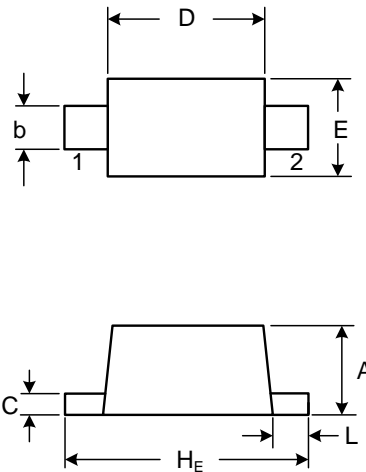
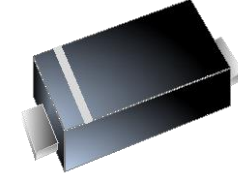
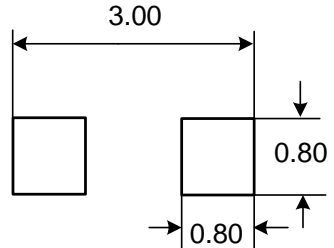


**Quadrant Assignments For PIN1 Orientation In Tape**




RD	Reel Dimensions	7 inch
W	Overall width of the carrier tape	8 mm
P1	Pitch between successive cavity centers	4mm

Outline Drawing – SOD-323F

<p><b>PACKAGE OUTLINE</b></p> 	 <p>SOD-323F</p> <table border="1" style="width: 100%; border-collapse: collapse; margin-top: 10px;"> <thead> <tr> <th rowspan="2">SYMBOL</th> <th colspan="3">MILLIMETERS</th> </tr> <tr> <th>MIN</th> <th>TYP</th> <th>MAX</th> </tr> </thead> <tbody> <tr> <td>A</td> <td>0.60</td> <td>0.65</td> <td>0.75</td> </tr> <tr> <td>b</td> <td>0.25</td> <td>0.30</td> <td>0.40</td> </tr> <tr> <td>C</td> <td>0.06</td> <td>0.13</td> <td>0.21</td> </tr> <tr> <td>D</td> <td>1.60</td> <td>1.70</td> <td>1.80</td> </tr> <tr> <td>E</td> <td>1.15</td> <td>1.25</td> <td>1.35</td> </tr> <tr> <td>H<sub>E</sub></td> <td>2.30</td> <td>2.50</td> <td>2.70</td> </tr> <tr> <td>L</td> <td>0.30</td> <td>0.40</td> <td>0.50</td> </tr> </tbody> </table>	SYMBOL	MILLIMETERS			MIN	TYP	MAX	A	0.60	0.65	0.75	b	0.25	0.30	0.40	C	0.06	0.13	0.21	D	1.60	1.70	1.80	E	1.15	1.25	1.35	H <sub>E</sub>	2.30	2.50	2.70	L	0.30	0.40	0.50
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 <p>DIMENSIONS: MILLIMETERS</p>	<p><b>Notes:</b> Controlling Dimension: Millimeter.</p>																																			

Marking Codes

Part Number	Marking Code
WS4.5D3HP	 <p>H=Specific Device Code X=Annual production times</p>

Package Information

Qty: 3k/Reel

CONTACT INFORMATION

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Tel: 86-21-68969993 Fax: 86-21-50757680 Email: [market@way-on.com](mailto:market@way-on.com)

WAYON website: <http://www.way-on.com>

For additional information, please contact your local Sales Representative.

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Specifications are subject to change without notice.  
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.  
Users should verify actual device performance in their specific applications.